

The main objectives of TEQIP-II project are Strengthening Institutions to improve Learning Outcomes and Employability of Students. Many organizations visiting campuses for recruitment point out that the employability of students are not as expected due to poor communication and professional skills.

The broad objectives of high intensity training on “Electronic Chip level training” are

1. To provide students with the necessary skills and abilities to work as a trained professional Chip Level Service Provider.
2. To make the participant completely knowledgeable in the emerging trends in the electronics chip level service industry and to provide an in-depth coverage on chip-level troubleshooting of laptop, motherboards and other logic and power electronic circuits.
3. To assist the Placement Cell of the College for placement drives.

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